







Call for Papers **NordPac Conference** 11 - 13 June 2024

Tampere, Finland Jointly arranged by: **IMAPS Nordic IEEE EPS Nordic**

We are proud to announce that the NordPac 2024 conference will be held Tampere, Finland. This is a perfect opportunity for you to present your revolutionary work within the field of microelectronic packaging while enjoying the normally beautiful weather in Tampere in June.

Abstract submission

We hereby invite you to prepare an abstract for the conference. For NordPac 2024 we have expanded the possibilities for how you want to present you work. We will open three submission tracks:

- Track 1 will require a full paper submission (4-6 pages). Accepted papers will be submitted for inclusion into IEEE Xplore subject to meeting IEEE Xplore's scope and quality requirements. (http://ieeexplore.ieee.org/).
- Track 2 will only require an extended abstract (1-2 pages) and will only be published in the conference proceedings.
- Track 3 is reserved for commercial white papers (1-4 pages) and will only be published in the conference proceedings. Presentations from all three tracks can appear in the same technical session.

The abstract submission deadline for all three tracks is January 31st, 2024.

Acceptance will be given within February 28th. After this, the three tracks follow different submission deadlines as indicated in the table below.

For full instructions on how to submit your paper and information on review process flow, please go to www.nordpac.org

Summary of deadlines

Conference portal open for submission	October 2023
Abstract submission	January 31st , 2024
Feedback on abstract	February 28 th , 2024
Track 1 – Full paper submission	April 30 th , 2024
Track 2 – Extended abstract submission	May 15 th , 2024
Track 3 – Commercial white paper submission	May 15 th , 2024
Notification of acceptance of all submissions	June 1 st , 2024

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Topics

Proposed topics of microelectronics and packaging include:

Optoelectronics	Harsh environment Applications	
Advanced Packaging	Electronics Reliability & Quality	
Materials & Processes	Medical electronics	
Power electronics	Wearable electronics	
Green Technologies	Printed electronics	
Advanced packaging for MEMS & sensors & sensor systems		

About the conference

The event brand NordPac was introduced in Gothenburg in 2017 as a collaboration between IMAPS Nordic and IEEE Electronics Packaging Society (EPS) Nordic. NordPac prides itself on being a small and specialised conference where networking is easy.

Reviewed papers will be submitted for publication in IEEE-Xplore with a licence to publish. The Licence allows the author to retain the copyright for the work and can publish it six months after the work has been published in IEEE-Xplore.

For the latest information about the conference and the exhibition, visit our homepage at www.nordpac.org or email to info@nordpac.org.

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